

# **Description**

Xsis Electronics "XRH35x" Series High Temperature crystal units are designed and processed to operate over an extended temperature range of -55 °C to 230 °C. These crystal units are offered in hermetically sealed cold welded industry standard TO-5 package in 3 different package height options.

High temperature materials and proven processes are utilized to provide high reliability and long life at extreme temperatures.

### **Features**

- > 3000G (0.5 mS) Shock Resistance
- 100% testing over operating temperature range
- Low Phase Noise
- Hermetically Sealed, Cold Weld, Metal Package
- Made in USA, ECCN: EAR99

# **Applications**

- Downhole Drilling Operations
- High Shock & Vibration
- High Temperature Avionics
- Gun Launched Munitions
- Jet Engine Sensors

# **Package Specifications &**

• Cover Material: OFHC Copper

• Cover Finish: 100 to 200 microinches Electroless Nickel

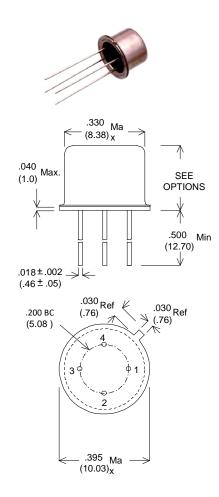
• Lead Material: Kovar,

• Lead Finish: 6 -15 micro-inches gold over 100 microinches Min. Nickel

• Base Material: 30/70 Copper Clad Kovar

Base Finish: 6 -15 microinches gold over 100 microinches Min. Nickel

• Weight: 1.2g Typical, 1.5g Max



| PIN#  | FUNCTION |  |
|-------|----------|--|
| 1     | CRYSTAL  |  |
| 3     | CRYSTAL  |  |
| 2 & 4 | N/C      |  |

Contact Xsis Electronics at xsis@xsis.com for any special requirements.

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#### ORDERING INFORMATION (Please build your part number from options below): 40.000 MHz, Fundamental Mode, 20 PF Load Capacitance, P/N EXAMPLE: XRH350 - 1F30 - 40M00000 = Frequency Accuracy of + 100 PPM over -20 °C to +200 °C Frequency F 30 XRH 350 Frequency Accuracy Vs, Operating Package **Package Temperature Range Options** Options Height **21** = $\pm$ 40 PPM over -20 °C to +150 °C \*\*\* 350 0.265" Max **Load Capacitance** Mode **22** = $\pm 100 \text{ PPM}$ over $-20 \,^{\circ}\text{C}$ to $+150 \,^{\circ}\text{C}$ \* **Options** 351 0.220" Max 1 = Fundamental **23** = + 150 PPM over -20 °C to +150 °C \* Series 352 0.208" Max 3 = 3<sup>rd</sup> Overtone Α 8 pF **24** = $\pm$ 40 PPM over -20 °C to +180 °C \*\*\* 5 = 5<sup>th</sup> Overtone В 10 pF **25** = $\pm 100$ PPM over -20 °C to $\pm 180$ °C \*\*\* C 12 pF **26** = $\pm 150$ PPM over -20 °C to $\pm 180$ °C \* D 15 pF **27** = $\pm 100$ PPM over -55°C to $\pm 180$ °C \*\*\* F 18 pF **28** = +150 PPM over -55 °C to +180 °C \* 20 pF F **29** = +250 PPM over -55 °C to +180 °C \* G 25 pF **30** = $\pm 100$ PPM over -20 °C to +200 °C \*\*\* н 30 pF Z = Custom **31** = $\pm$ 150 PPM over -20 °C to +200 °C \*\*\* **32** = $\pm 200$ PPM over -20 °C to $\pm 200$ °C \* **33** = +250 PPM over -20 °C to +200 °C \* over -55°C to +200°C \*\*\* **34** = <u>+</u> 100 PPM **35** = $\pm 150$ PPM over -55 °C to $\pm 200$ °C \*\*\* **36** = $\pm 200$ PPM over -55 °C to +200 °C \* **37** = $\pm 250$ PPM over -55 °C to +200 °C \* 38 = +200 PPM over $-55 \,^{\circ}\text{C}$ to $+220 \,^{\circ}\text{C}$ \*\*\* **39** = +300 PPM over -55 °C to +220 °C \* **40** = +250 PPM over -20°C to +230°C \*\*\* **41** = $\pm 350$ PPM over -20°C to +230°C \* **42** = $\pm 250$ PPM over -55 °C to $\pm 230$ °C \*\*\*

**43** =  $\pm$ 350 PPM over -55°C to +230°C \* **44** =  $\pm$ 45 PPM over -20°C to +180°C \*\*\* **45** =  $\pm$ 300 PPM over -55°C to +200°C \*

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<sup>\*\*\*</sup> Tight Stability

<sup>\*</sup> Standard Stability



Table I - Electrical Specifications, Fundamental, 3rd and 5th Overtone Oscillation modes

| Parameter   | Fundamental                        | 3 <sup>rd</sup>             | 5 <sup>th</sup>              |
|---|------------------------------------|-----------------------------|------------------------------|
| Nominal Frequency Range   | 6.4 MHz to 40.0 MHz                | 40.0 MHz to 150.0 MHz       | 75.0 MHz to 200.0 MHz        |
| Mode  | Fundamental                        | 3 <sub>rd</sub>             | 5 <sup>th</sup>              |
| Resonance Type  | See Ordering Information           |                             |                              |
| Load Capacitance  | See Ordering Information           |                             |                              |
| Frequency Accuracy Vs. Temperature  | See Ordering Information           |                             |                              |
| Resistance (ESR) 6.4 to 20 MHz 20.1 to 40 MHz 40.0 to 90 MHz 90.1 to 150 MHz 75.0 to 125 MHz 125.1 to 200 MHz | 40 Ohms Max.<br>30 Ohms Max.       | 50 Ohms Max<br>60 Ohms Max. | 70 Ohms Max.<br>80 Ohms Max. |
| Shunt Capacitance   | 7 pF Max.                          |                             |                              |
| Unwanted Modes Resistance   | > 2 times the Main Mode Resistance |                             |                              |
| Storage Temperature   | -55 °C to +125 °C                  |                             |                              |
| Drive Level   | 50 μW Typical, 1 mW Max.           |                             |                              |
| Aging at 25°C per year  | ± 3 PPM Max                        |                             |                              |

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### **Table II - Environmental Specifications:**

Crystal Units shall be able to withstand any of the following environmental stresses with change in Frequency of less than 5 PPM and change in resistance of less than 10%.

| Test - Inspection   | Test Method - Condition  |
|---------------------|--|
| Shock               | MIL-STD-202, Method 213, Cond. C                                       |
| Vibration           | MIL-STD-202, Method 204, Cond. A, 3 hours minimum.                     |
| Thermal Shock       | MIL-STD-202, Method 107, Cond. B                                       |
| Moisture Resistance | MIL-STD-202, Method 106, except Step 7b, Vibration, is not applicable. |

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## Table III - 100% Screening per MIL-PRF-3098, Class B

| Test - Inspection                                   | Test Method – Condition   |
|---|---|
| Pre-seal Visual Examination                         | MIL-PRF-3098, Method 4.10.2.2                                     |
| Stabilization Bake ( Prior to Seal )                | MIL-STD-883, Method 1008, Condition C (+150 °C), 24 hours minimum |
| Seal (Fine and Gross Leak)                          | MIL-PRF-3098, Para. 4.10.26                                       |
| Frequency and Resistance over Operating Temperature | MIL-PRF-3098, Para. 4.10.18                                       |
| External Visual & Mechanical                        | MIL-PRF-3098, Para. 4.10.2.1                                      |

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### **Table IV - Environmental**

**XRH35x** series crystal units are designed to meet or exceed the Environmental tests specified below. Customized screening and environmental testing are also available to meet your special requirements.

| Test                          | Test Conditions  |
|-------------------------------|--|
| Mechanical Shock:             | 3000G, 0.5 mS shock.   |
| Vibration, Random:            | 20G RMS, 10 Hz to 2000 Hz  |
| Thermal Shock:                | MIL-STD-202, Method 107, Condition B                                       |
| Temperature Cycle:            | MIL-STD-883, Method, 1010, Condition B                                     |
| Moisture Resistance:          | MIL-STD-202, Method 106  |
| Salt Atmosphere:              | MIL-STD-202, Method 101  |
| Acceleration:                 | MIL-STD-883, Method 2002, Condition A, 5000G                               |
| Terminal Strength:            | MIL-STD-202, Method 211. Cond. A(4 pound for Pins, 2 pound for wire leads) |
| Fine Leak:                    | MIL-STD-202, Method 112, Condition C-IIIc (1x10-8 atm-cc/sec)              |
| Gross Leak:                   | MIL-STD-202, Method 112, Condition D                                       |
| Solderability:                | MIL-STD-202, Method 208 ( ANSI-EIA-J-STD-002 )                             |
| Resistance to Soldering Heat: | MIL-STD-202, Method 210, Condition B or C                                  |
| Resistance to Solvents:       | MIL-STD-202, Method 215  |
| Low Temperature Storage:      | MIL-PRF-3098   |

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